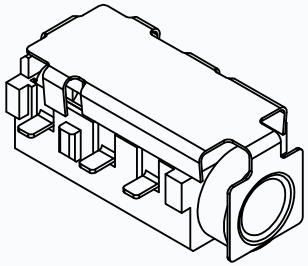
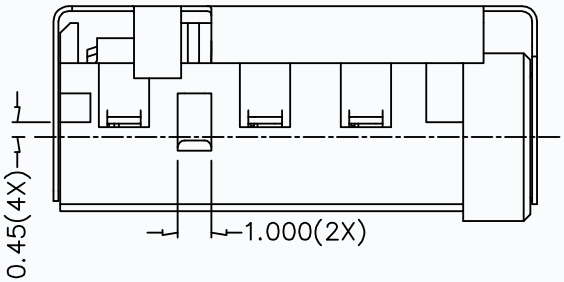
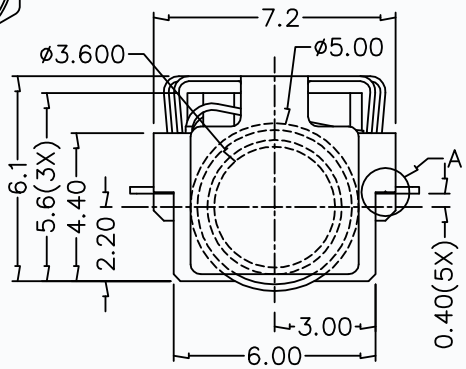
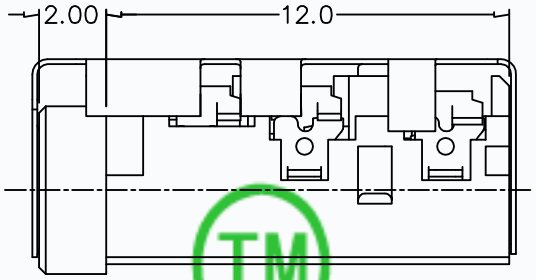
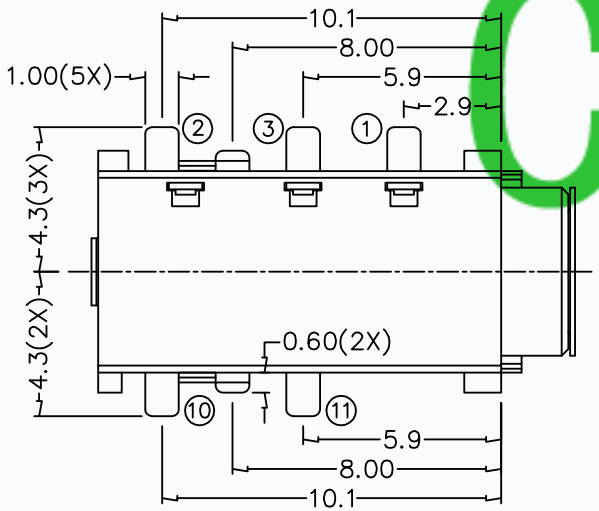
CAD FILE:

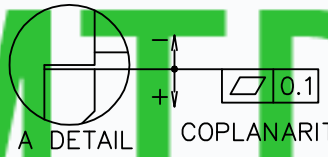








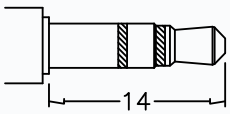




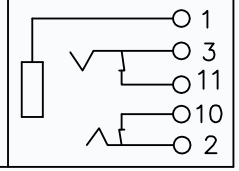
0.1
COPLANARITY

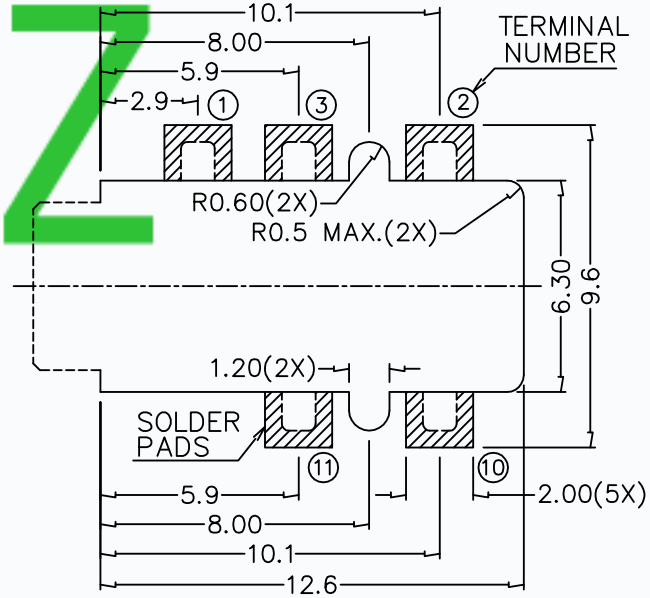
* MATERIAL

TERMINAL 1	: COPPER ALLOY
TERMINAL 2	: COPPER ALLOY
TERMINAL 3	: COPPER ALLOY
TERMINAL 10	: COPPER ALLOY
TERMINAL 11	: COPPER ALLOY
SHIELD	: STAINLESS STEEL
HOUSING	: PA6T



ø3.5 MATE PLUG

MODEL NO.	T13-3521D
SCHEMATIC	



RECOMMENDED SOLDER PAD LAYOUT (TOP VIEW)

CMTDDZ

		TOLERANCE UNLESS SPECIFIED WITHIN 1.5mm : ±0.1mm OVER 1.5mm : ±0.2mm	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF DONGGUAN TIANDU ELECTRONICS CO.,LTD. AND SHALL NOT BE REPROOUCED. COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF DONGGUAN TIANDU ELECTRONICS CO., LTD	TITLE : 3.5mm SMD PHONE JACK	UNIT : mm	DRWG NO.: CMTDDZ-T13-3521D-00	
				MODEL: T13-3521D	SCALE: 3:1	DWN. ERIC 2013-6-17	
				CMTDDZ 东莞市田都电子有限公司 DONGGUAN TIANDU ELECTRONICS CO.,LTD.		CHK'D MAIKO 2013-6-17	
APPD.	DESCRIPTIONS OF REVISION					APPD. Coco 2013-6-17	